



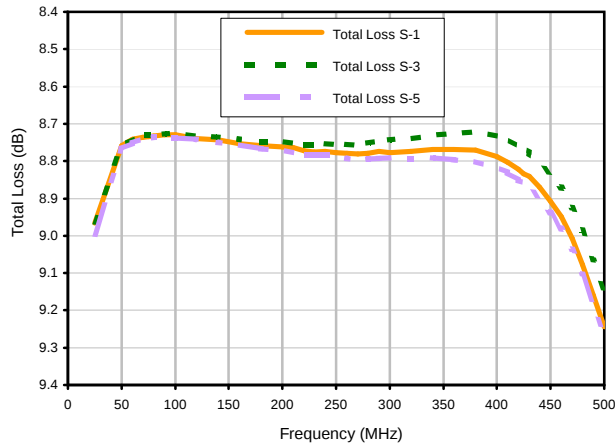




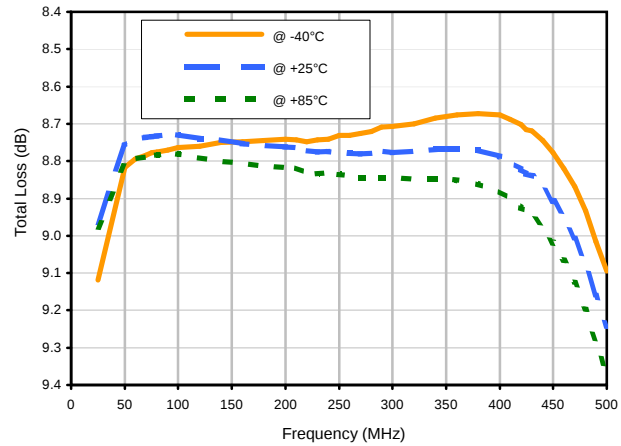


## Typical Performance Curves

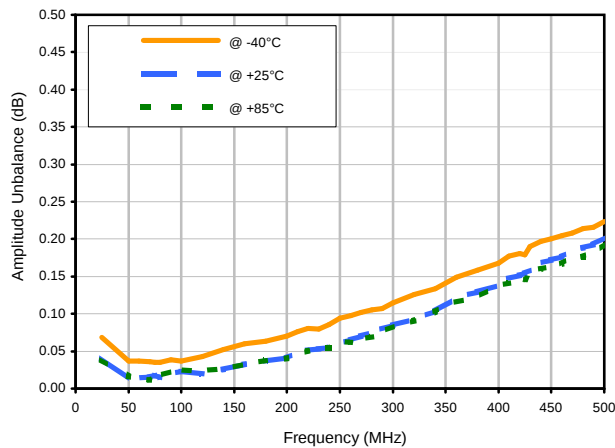
**Total Loss**



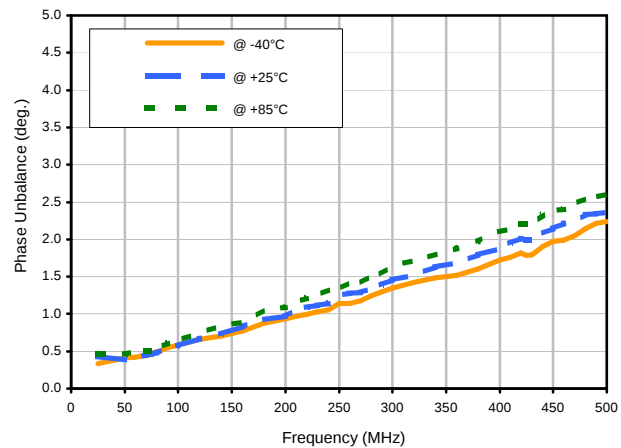
**Total Loss S-1 vs. TEMPERATURE**



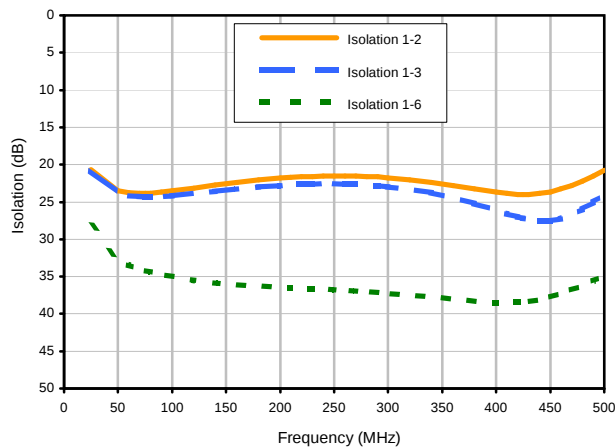
**Amplitude Unbalance vs. TEMPERATURE**



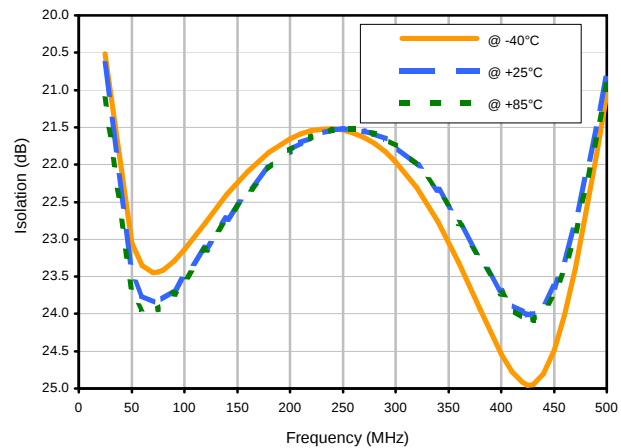
**Phase Unbalance vs. TEMPERATURE**



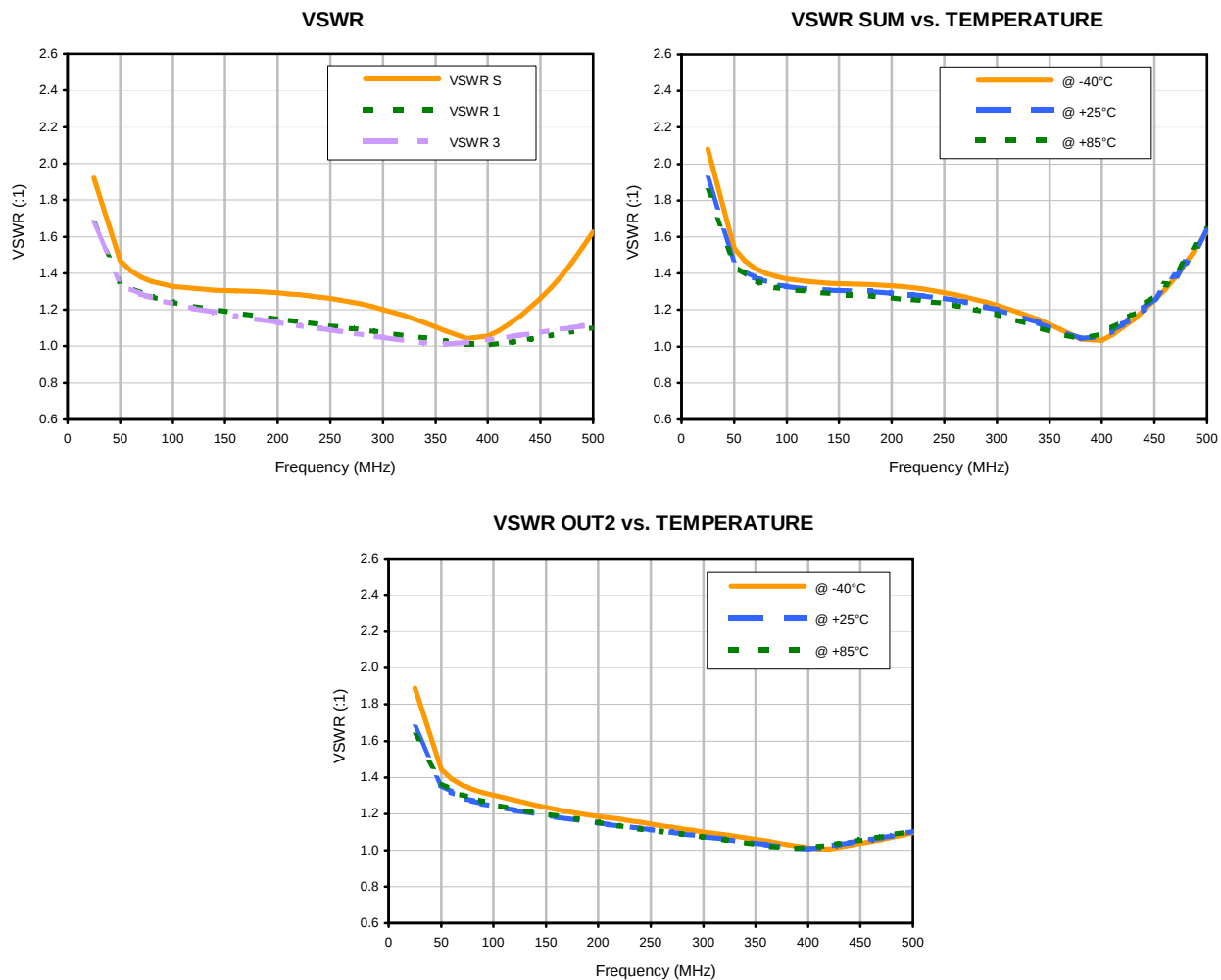
**Isolation**



**Isolation 1-2 vs. TEMPERATURE**



## Typical Performance Curves



REV. X2

JCPS-6-3

100623

Page 2 of 2



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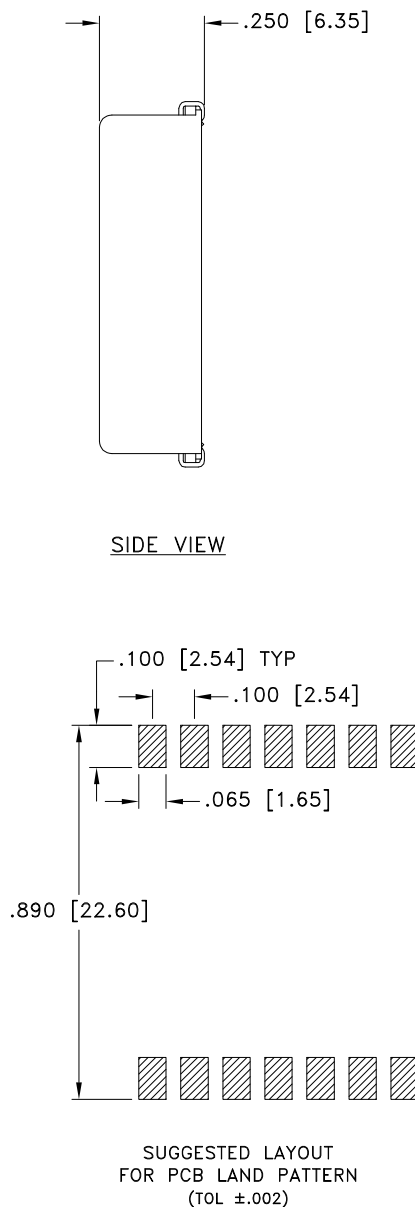
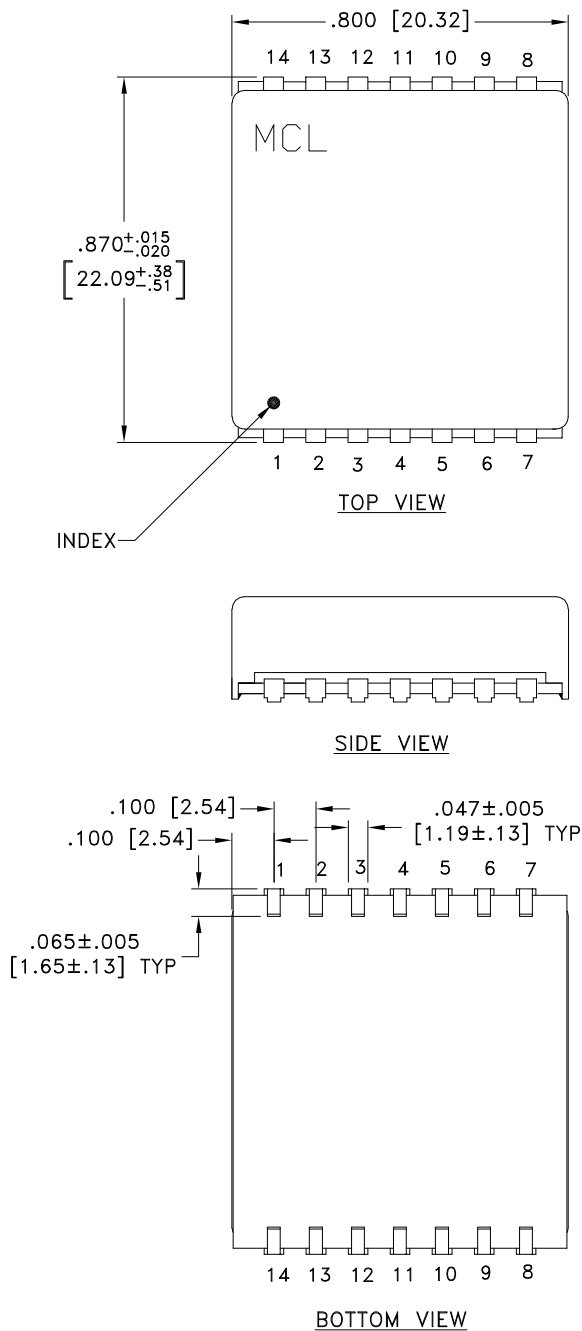


The Design Engineers Search Engine finds the model you need, Instantly • For detailed performance specs & shopping online see



## Outline Dimensions

BG291



DENOTES METALLIZATION

Weight: 4 gram

Dimensions are in inches[mm]. Tolerances: 2PL $\pm$ 0.03[0.76]; 3 PL $\pm$ 0.015 [0.381] inches[mm], unless otherwise specified

### Notes:

1. Case material: Copper-Nickel alloy.
2. Base material: Printed wiring laminate.
3. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

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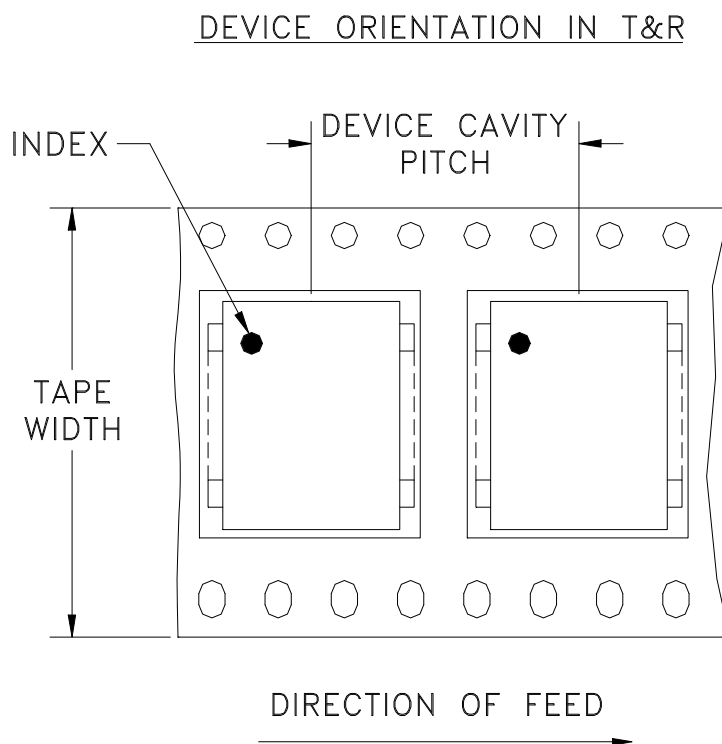
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RF/IF MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F21



| Tape Width,<br>mm | Device Cavity<br>Pitch, mm | Reel Size,<br>inches | Devices per Reel |
|-------------------|----------------------------|----------------------|------------------|
| 32                | 32                         | 13                   | 200              |

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)



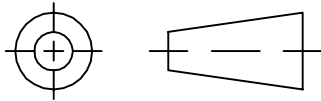
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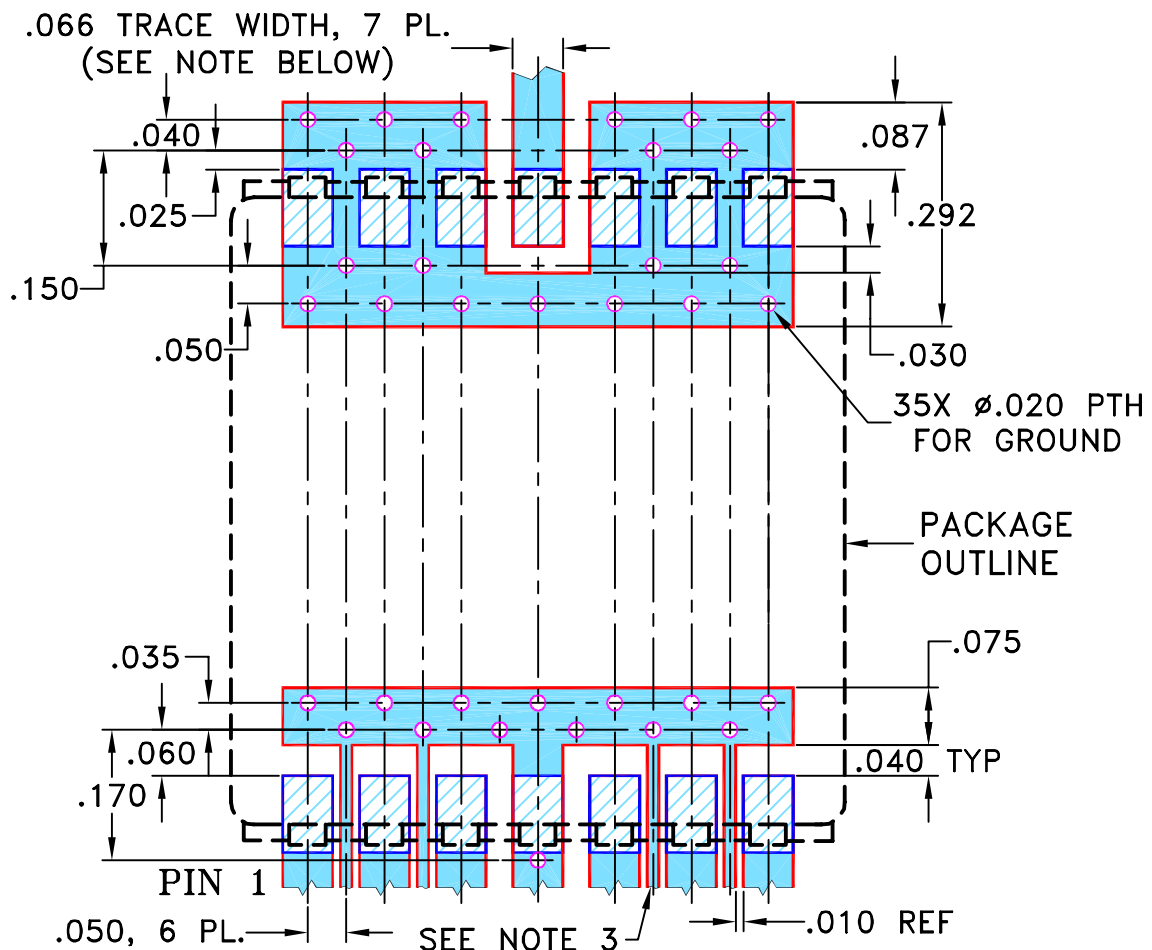
## THIRD ANGLE PROJECTION



## REVISIONS

| REV | ECN No. | DESCRIPTION           | DATE     | DR  | AUTH |
|-----|---------|-----------------------|----------|-----|------|
| OR  | M88786  | NEW RELEASE           | 10/06/05 | MMG | HY   |
| A   | M102713 | ADDED "...WITH SMOBC" | 01/16/06 | GF  | IL   |
|     |         |                       |          |     |      |
|     |         |                       |          |     |      |

### SUGGESTED MOUNTING CONFIGURATION FOR BG291 CASE STYLE, "mf" PIN CONNECTION



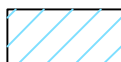
NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

3. IF DESIGN RULES ALLOW, EXTEND GROUND AS SHOWN TO ACHIEVE BETTER ISOLATION.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

MMG

09/28/05

TOLERANCES ON:  
2 PL DECIMALS ±  
3 PL DECIMALS ± .005

CHECKED

AV

10/06/05

APPROVED

HY

10/06/05

ANGLES ±  
FRACTIONS ±

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ASHEETA1.DWG REV:A DATE:01/12/95



Mini-Circuits®

13 Neptune Avenue  
Brooklyn NY 11235

PL, mf, BG291, JCPS-6-3, TB-234

SIZE  
A

CODE IDENT  
15542

DRAWING NO:  
98-PL-139

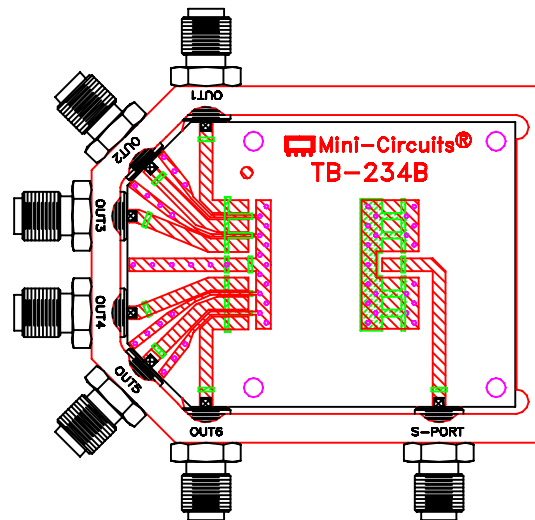
REV:  
A

FILE: 98PL139

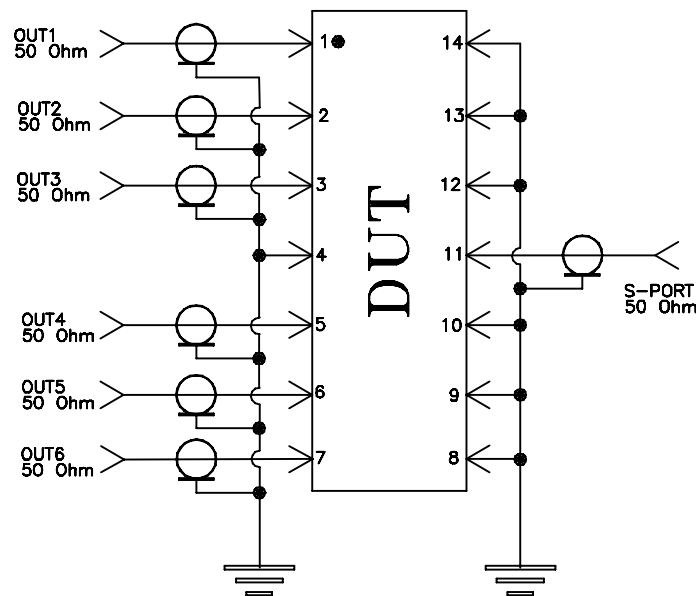
SCALE: 4:1

SHEET: 1 OF 1

# Evaluation Board and Circuit



TB-234



Schematic Diagram

## Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,  
Dielectric Constant=3.5, Thickness=.030 inch.

 Mini-Circuits®



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification                  | Test/Inspection Condition                                                                                                                                       | Reference/Spec                                                                                       |
|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|
| Operating Temperature          | -40° to 85°C<br>Ambient Environment                                                                                                                             | Individual Model Data Sheet                                                                          |
| Storage Temperature            | -55° to 100° C<br>Ambient Environment                                                                                                                           | Individual Model Data Sheet                                                                          |
| Humidity                       | 90 to 95% RH, 240 hours, 50°C                                                                                                                                   | MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours |
| Thermal Shock                  | -55° to 100°C, 100 cycles                                                                                                                                       | MIL-STD-202, Method 107, Condition A-3, except +100°C                                                |
| Solder Reflow Heat             | Sn-Pb Eutetic Process: 225°C peak<br>Pb-Free Process 245° - 250°C peak                                                                                          | J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1                                                        |
| Solderability                  | 10X Magnification                                                                                                                                               | J-STD-002, 95% Coverage                                                                              |
| Vibration (High Frequency)     | 20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)                                                                             | MIL-STD-202, Method 204, Condition D                                                                 |
| Mechanical Shock               | 50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes                                                                                               | MIL-STD-202, Method 213, Condition A                                                                 |
| Marking Resistance to Solvents | Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C;<br>distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C | MIL-STD-202, Method 215                                                                              |